MEMS THERMAL ACTUATOR BASED VARACTOR

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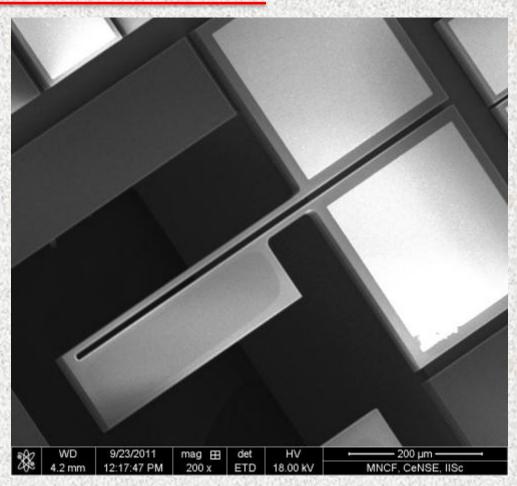
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The Plan

- ✓ Introduction
 - > Advantages of using thermal actuator
- ✓ Design of suitable thermal actuator for varactor application
- ✓ Geometrical modeling
- ✓ Analytical modeling
- ✓ Temperature Profile
- ✓ Deflection
- ✓ Varactor

Introduction

✓ Thermal actuator



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Advantages

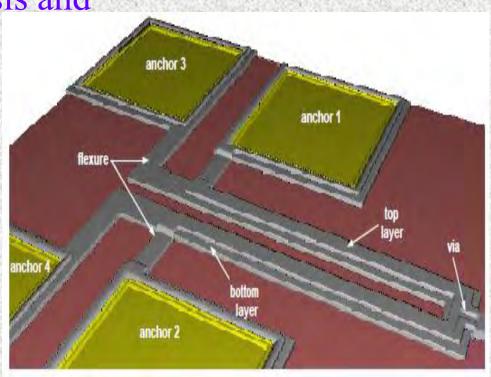
- ✓ Avoiding the static charges collecting on the plates
- ✓ Improvement in the reliability,
- ✓ Lower driving voltages and mainly
- ✓ No pull in effect..
- ✓ Used in micro legs, micro grippers, micro positioning applications etc.
 - > And in varactor

Design of a Bidirectional Vertical Thermal Actuator

✓ Geometric Modelling

✓ Electro thermal analysis and

✓ Mechanical analysis

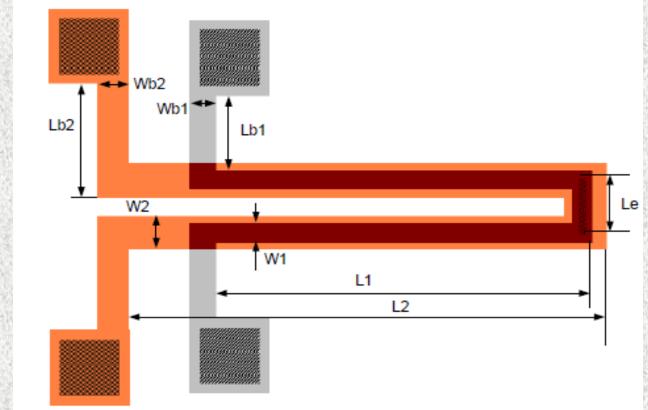


Schematic Top View Diagram of a U-shaped VTA

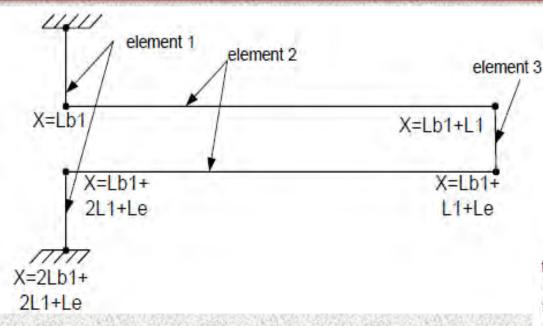
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Analytical Modeling

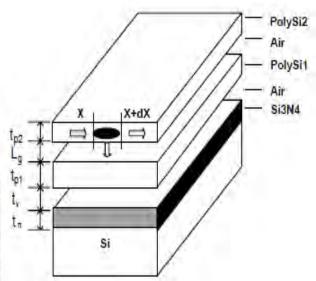
- ✓ The electro-thermal analysis of the U-shape VTA can be simplified as one dimensional heat transfer problem.
- ✓ Current is assumed to pass through only top layer of the actuator



Analytical Modeling



✓ There are five microbeams connected to each other.



One element for analysis

Electrothermal Equation

- ✓ Heat balance
- ✓ Only the heat loss through conduction and convection is considered
 - ➤ Heat dissipated through radiation to the ambient is neglected.
- ✓ Under steady-state conditions, Ohmic power generated in the element is equal to heat conduction and convection out of the element,

$$-K_P wt \left[\frac{dT}{dx}\right]_x + J^2 \rho wt dx = -K_P wt \left[\frac{dT}{dx}\right]_{x+dx} + \frac{Sw(T - T_S)dx}{R_T}$$

$$T = T_s + \frac{B}{A^2} + C_1 e^{Ax} + C_2 e^{-Ax}$$

Material Properties used in modeling

Material Properties	Value	Unit
Young's modulus E	162 × 10 ⁹	Pa
Poisson's ratio ${m v}$	0.22	
Thermal expansion coefficient K	4.7×10^{-6}	C^{-1}
Thermal conductivity of polysilicon k_p	41× 10 ⁻⁶	$W.\mu m^{-1}.C^{-1}$
Thermal conductivity of air k_v	0.026× 10 ⁻⁶	$W.\mu m^{-1}.C^{-1}$
Thermal conductivity of nitride k_n	2.25× 10 ⁻⁶	$W.\mu m^{-1}.C^{-1}$
Resistivity of polysilicon Po	20	Ω . μ m
Linear temperature	125× 10 ⁻³	C ⁻¹
Coefficient 🗲		

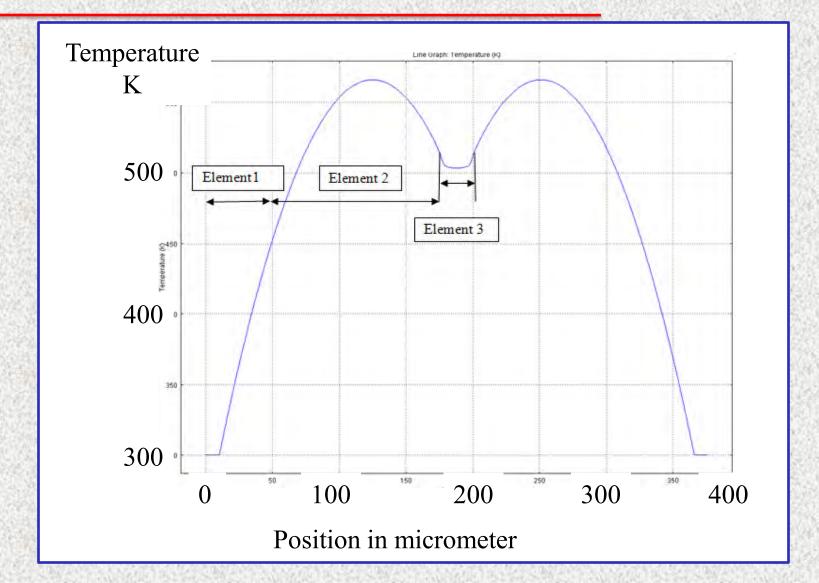
Geometrical Data

Geometrical data	Value	Unit
The length of the long beam of the top layer L1	177	μm
The length of the long beam of the bottom layer L2	217	μm
The length of the short bar of the top layer Lb1	50	μm
The length of the short bar of the bottom layer Lb2	60	μm
The width of the long beam of the top layer w1	10	μm
The width of the long beam of the bottom layer w2	18	μm
The width of the short bar of the top layer wb1	13	μm
The width of the short bar of the bottom layer wb2	15	μm
The length of the connection between two long beams Le	38	μm
The gap between the top layer and the bottom layer	0.75	μm
The thickness of the top layer Tp2	1.5	μm
The thickness of the bottom layer Tp1	2.0	μm
The thickness of air Tv	2	μm
The thickness of nitride Tn COMSOL CONFERENCE Bangalore	0.6	μm

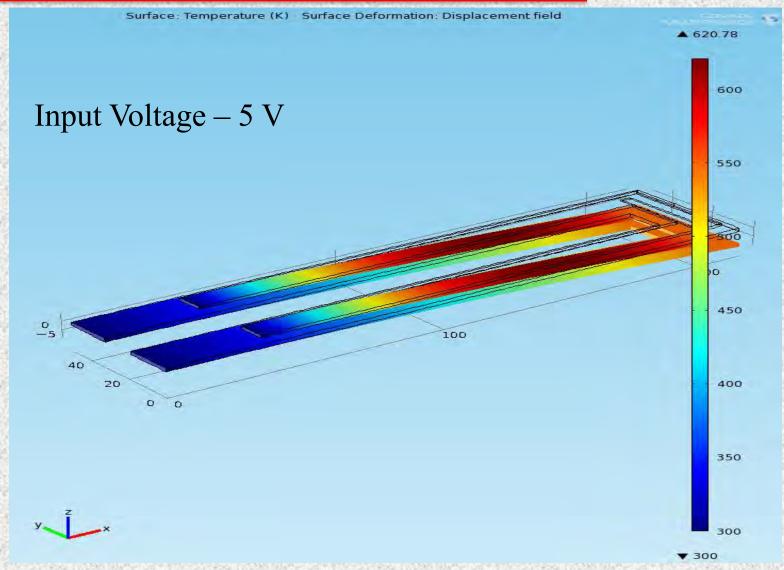
Temperature distribution

- ✓ Input voltage 4V,
- ✓ Since the U-shaped vertical thermal actuator is symmetrical about its centre line, the temperature distribution also should be symmetrical about its centre line.

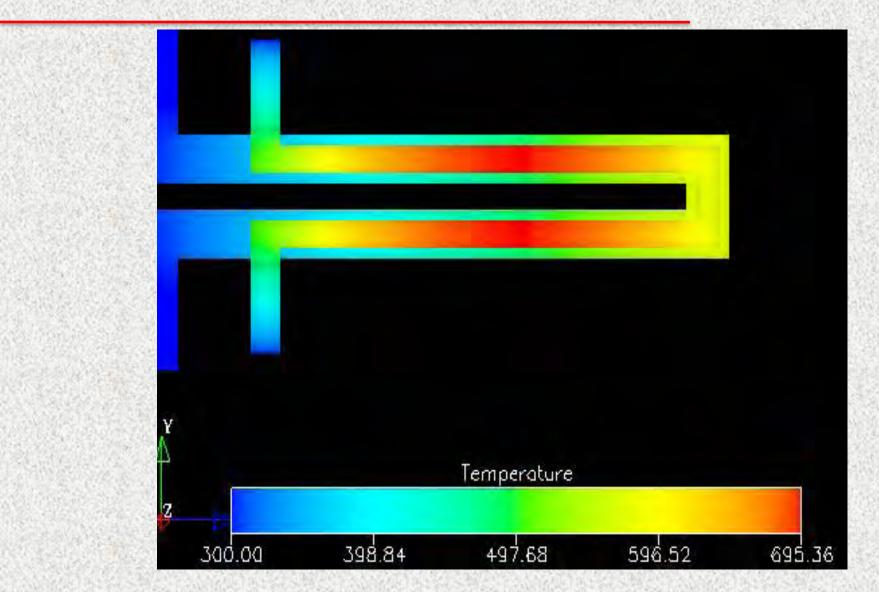
Simulation Results



Temperature distribution

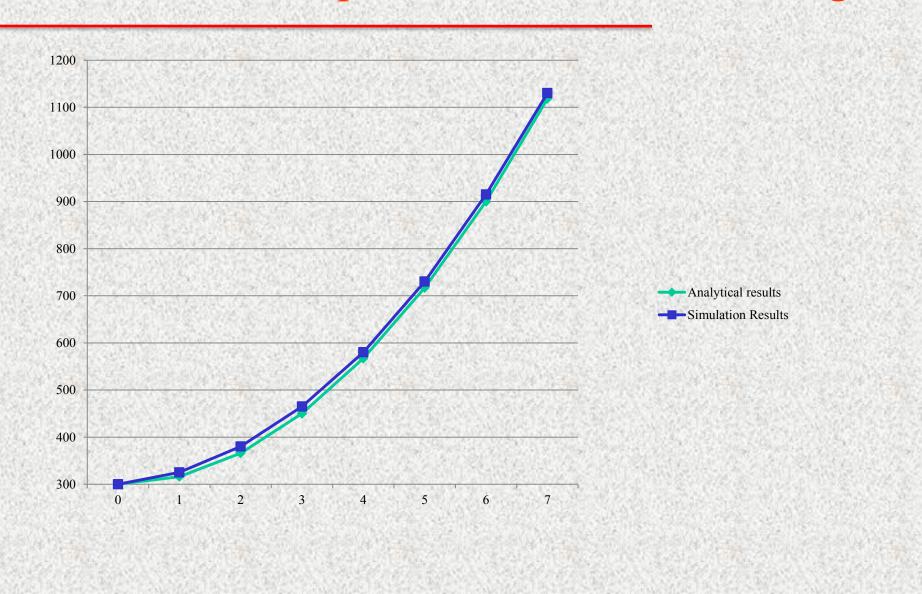


Input Voltage – 5 N



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Maximum temperature at different voltage



Deflection downwards

COMSOL results with the voltage is applied to anchor 1 and 2

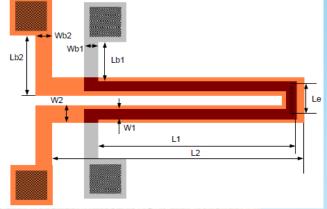
Surface Total displacement (µm) Surface Deformation: Displacement field

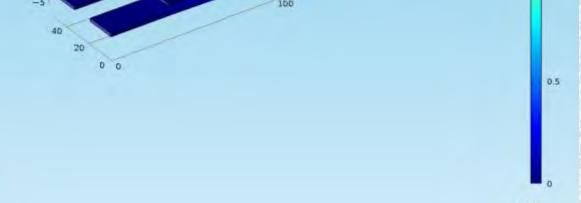
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VWD2
VWD1

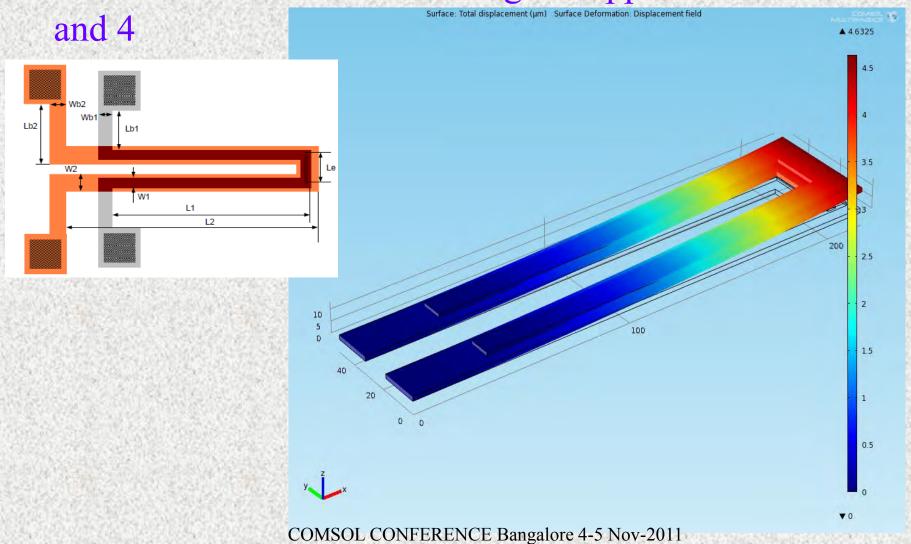
LD1





Deflection upwards

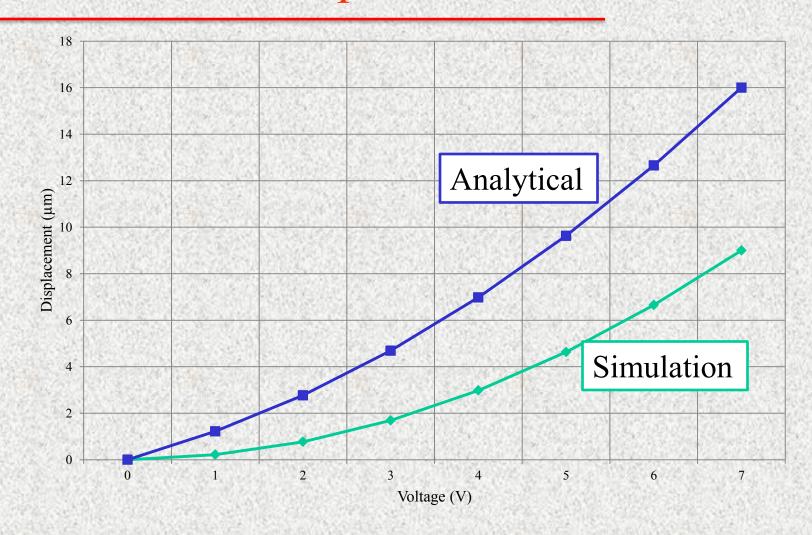
✓ Comsol results with the voltage is applied to anchor 3



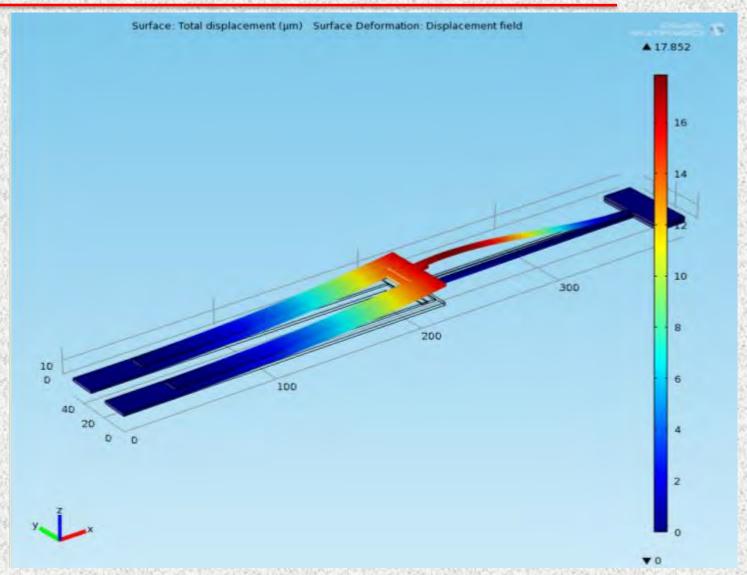
Deflection

$$u = \frac{1}{EI_1} \int_0^{L_1} M\overline{M} dx = \frac{1}{EI_1} \left(-\frac{1}{3} X_1 L_1^3 + \frac{1}{2} X_1 L_1^3 L_2 - \frac{1}{2} X_2 L_1^2 L_g \right)$$

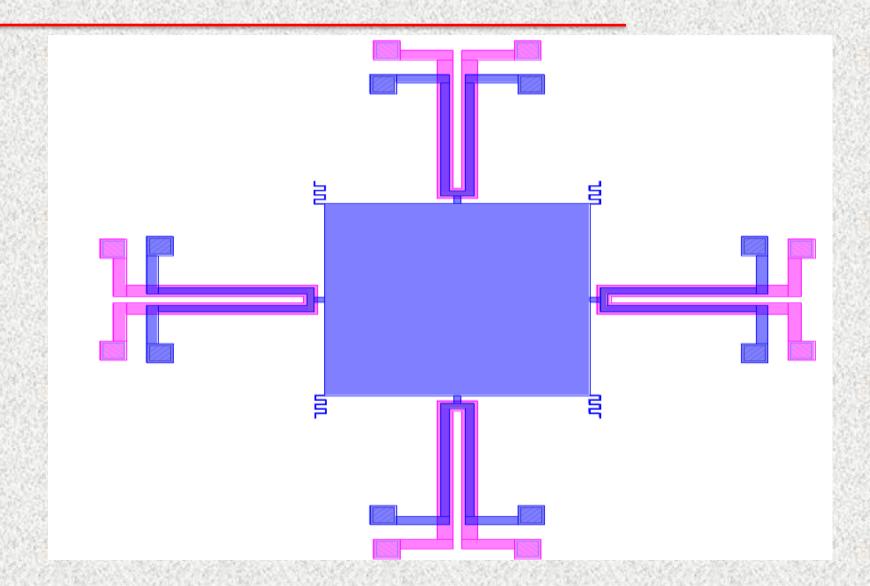
Displacement

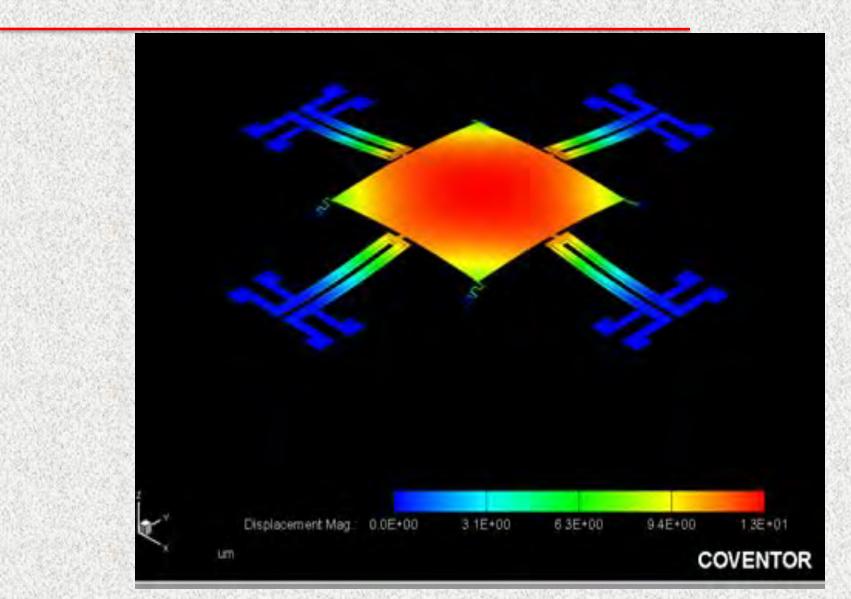


Simulation including Cantilever



Model of Varactor





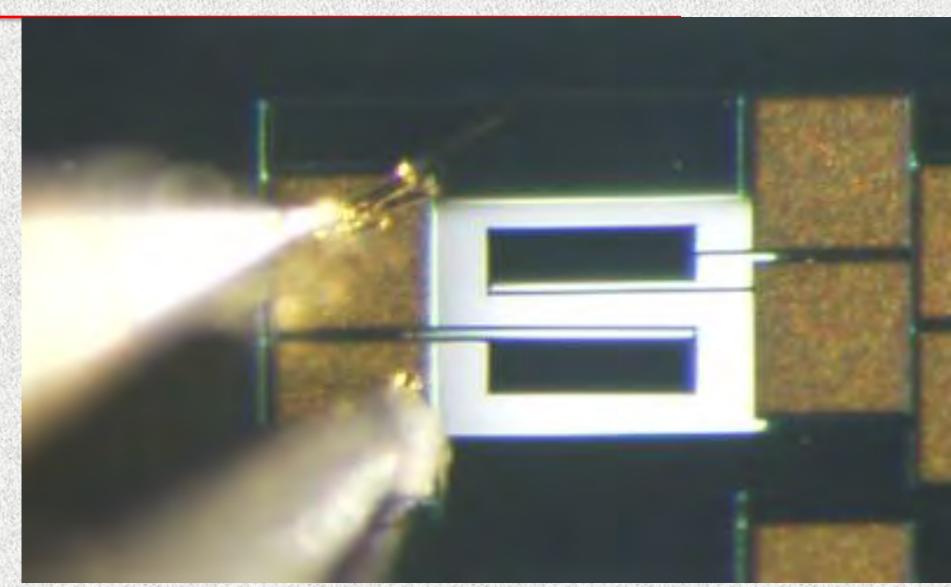
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Results

Voltage	Displacement(um)	Capacitance(pF)
1	0.38	2.2
2	1.213	0.7
3	2.6	0.3
4	4.54	0.175
5	7.03	0.079
6	10.08	0.079
7	13.69	0.058
8	17.8	0.0447

Acknowledgement

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